

FJNS3208R

Switching Application (Bias Resistor Built In) - Switching circuit, Inverter, Interface circuit, Driver Circuit

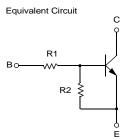
- Built in bias Resistor (R₁=47K Ω , R₂=22K Ω)
- Complement to FJNS4208R



NPN Epitaxial Silicon Transistor

Absolute Maximum Ratings Ta=25°C unless otherwise noted

Symbol	Parameter	Value	Units	
V _{CBO}	Collector-Base Voltage	50	V	
V _{CEO}	Collector-Emitter Voltage	50	V	
V _{EBO}	Emitter-Base Voltage	10	V	
I _C	Collector Current	100	mA	
P _C	Collector Power Dissipation	300	mW	
T _J	Junction Temperature	150	°C	
T _{STG}	Storage Temperature	-55 ~ 150	°C	



Electrical Characteristics T_a=25°C unless otherwise noted

Symbol	Parameter	Test Condition	Min.	Тур.	Max.	Units
BV _{CBO}	Collector-Base Breakdown Voltage	$I_{C}=10\mu A, I_{E}=0$	50			V
BV _{CEO}	Collector-Emitter Breakdown Voltage	$I_{C}=100\mu A, I_{B}=0$	50			V
I _{CBO}	Collector Cut-off Current	V_{CB} =40V, I_{E} =0			0.1	μΑ
h _{FE}	DC Current Gain	V _{CE} =5V, I _C =5mA	56			
V _{CE} (sat)	Collector-Emitter Saturation Voltage	I _C =10mA, I _B =0.5mA			0.3	V
f _T	Current Gain Bandwidth Product	I _C =10mA, I _B =0.5mA		250		MHz
C _{ob}	Output Capacitance	V _{CB} =10V, I _E =0 f=1.0MHz		3.7		pF
V _I (off)	Input Off Voltage	V _{CE} =5V, I _C =100μA	0.8			V
V _I (on)	Input On Voltage	V_{CE} =0.3V, I_{C} =2mA			4	V
R ₁	Input Resistor		32	47	62	ΚΩ
R ₁ /R ₂	Resistor Ratio		1.9	2.1	2.4	

Typical Characteristics

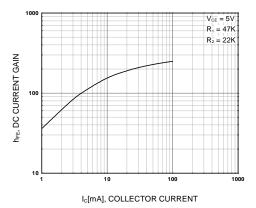


Figure 1. DC current Gain

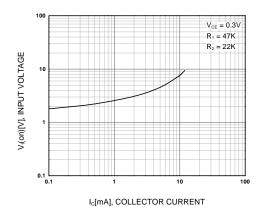


Figure 2. Input On Voltage

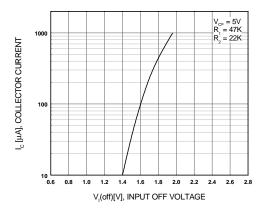


Figure 3. Input Off Voltage

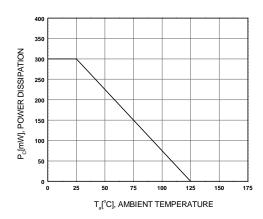
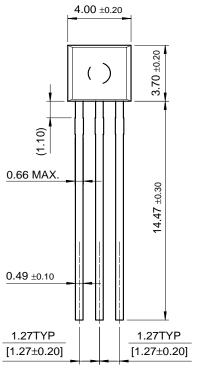
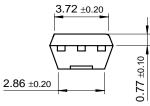


Figure 4. Power Derating

Rev. A, August 2002

TO-92S







Dimensions in Millimeters

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